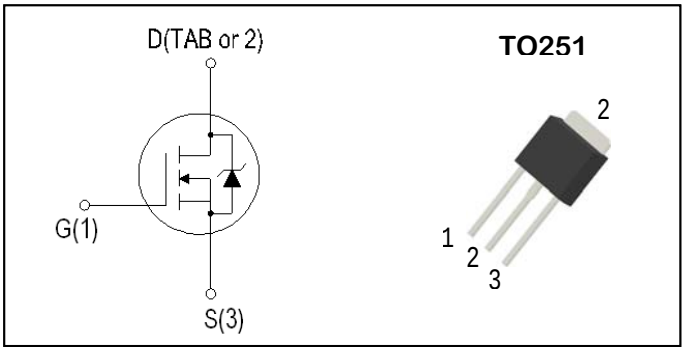
N-Channel Enhancement Mode Field Effect Transistor



PRODUCT SUMMARY

V_{DSS}	I_D	$R_{DS(ON)}$ (mΩ)
60V	40A	18mΩ

Absolute Maximum Ratings (T_A = 25°C unless otherwise specifed)

Symbol	Parameter		Ratings	Unit
Common Ratings				
V_{DSS}	Drain-Source Voltage		60	V
V_{GSS}	Gate-Source Voltage		±20	
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-55 to 175	°C
I_S	Diode Continuous Forward Current	TC=25°C	40	A
Mounted on Large Heat Sink				
I_{DM}	300μs Pulse Drain Current Tested(1)	T_C=25°C	90	A
I_D	Continuous Drain Current	T_C=25°C	40	A
P_D	Maximum Power Dissipation	T_C=25°C	20	W

1. Pulse width limited by maximum junction temperature.

Thermal Characteristics

Symbol	Parameter	Ratings	Unit
R_{thJC}	Thermal resistance junction-case max	2.0	°C/W
R_{thJA}	Thermal resistance junction-ambient max	40	°C/W

Electrical Characteristics (TA=25°C Unless Otherwise Noted)

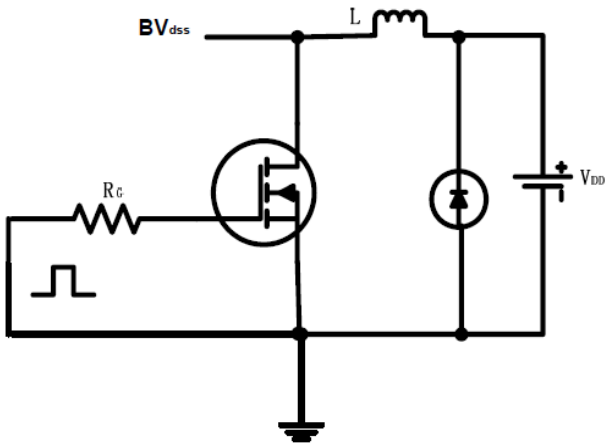
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
On/off Characteristics						
BV_{DSS}	Drain-Source Breakdown Voltage	V_{GS}=0V, I_{DS}=250uA	60	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}= 48V, V_{GS}=0V	--	--	1	uA
		V_{DS}=48V, V_{GS}=0V T_J=85°C	--	--	5	
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}, I_{DS}=250uA	1	--	4	V
I_{GSS}	Gate Leakage Current	V_{GS}=±20V, V_{DS}=0V	--	--	±100	nA
$R_{DS(ON)}$	Drain-SourceOn-stateResistance(2)	V_{GS}= 10V, I_{DS}=15A	--	16.0	18.0	mΩ
g_{FS}	Forward transconductance(2)	V_{DS}= 10V, I_{DS}=15A	--	14	--	S
Dynamic Characteristics						
C_{iss}	Input Capacitance	V_{GS}=0V,	--	540	--	pF
C_{oss}	Output Capacitance	V_{DS}= 25V,	--	74	--	
C_{rss}	Reverse Transfer Capacitance	Frequency=1.0MHz	--	34	--	
Switching Characteristics						
$t_{d(ON)}$	Turn-on Delay Time(1)	V_{DD}=30V,	--	6	--	ns
t_r	Turn-on Rise Time(1)	I_D= 5A, V_{GS}= 10V,	--	4.6	--	
$t_{d(OFF)}$	Turn-off Delay Time(1)	R_{GEN}=3Ω	--	22	--	
t_f	Turn-off Fall Time(1)		--	4	--	
Q_g	Total Gate Charge(1)	V_{DS}=30V, V_{GS}= 10V,	--	9	--	nC
Q_{gs}	Gate-Source Charge(1)	I_{DS}=12A	--	1.6	--	
Q_{gd}	Gate-Drain Charge(1)		--	1.8	--	
Diode Characteristics						
V_{SD}	Diode Forward Voltage(2)	I_{SD} = 1A, V_{GS} = 0	--	--	1.2	V
t_{rr}	Reverse Recovery Time	I_{SD}=15A, dI_{SD}/dt=50A/μs	--	42.0	--	ns
q_{rr}	Reverse Recovery Charge		--	31.0	--	nC

NOTES:

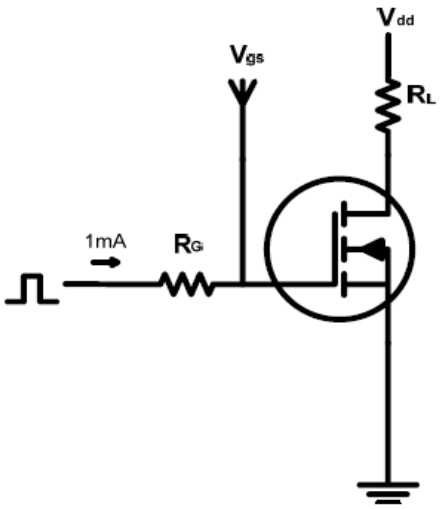
1. Independent of operating temperature.
2. Pulse Test : Pulse width ≤ 300μs, Duty cycle ≤ 2%

Test circuits and Waveforms

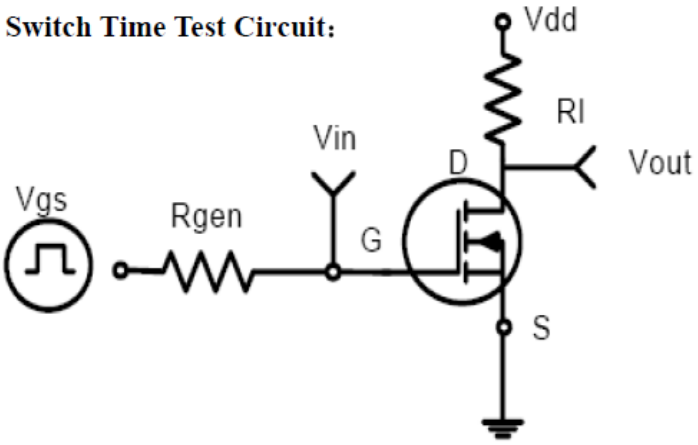
EAS test circuits:



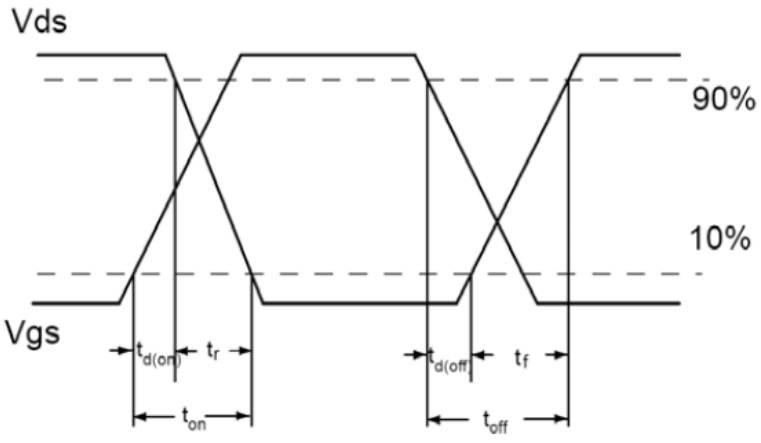
Gate charge test circuit:



Switch Time Test Circuit:

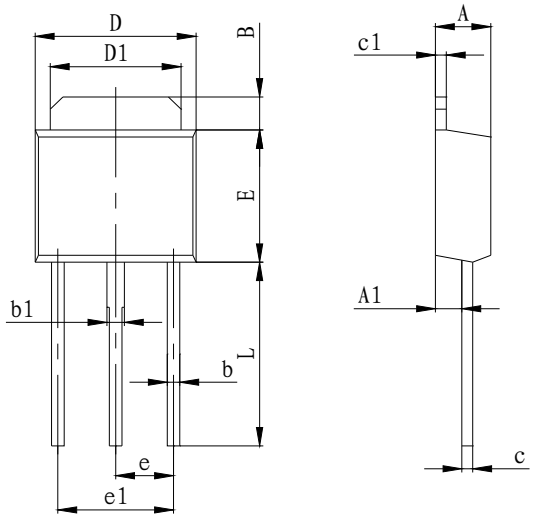


Switch Waveforms:



PACKAGE MECHANICAL DATA

TO-251 Package Dimension



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	2.200	2.400	0.087	0.094
A1	1.050	1.350	0.042	0.054
B	1.350	1.650	0.053	0.065
b	0.500	0.700	0.020	0.028
b1	0.700	0.900	0.028	0.035
c	0.430	0.580	0.017	0.023
c1	0.430	0.580	0.017	0.023
D	6.350	6.650	0.250	0.262
D1	5.200	5.400	0.205	0.213
E	5.400	5.700	0.213	0.224
e	2.300TYP		0.091TYP	
e1	4.500	4.700	0.177	0.185
L	7.500	7.900	0.295	0.311